

A suffix of "-C" specifies halogen & lead-free

**FEATURES**

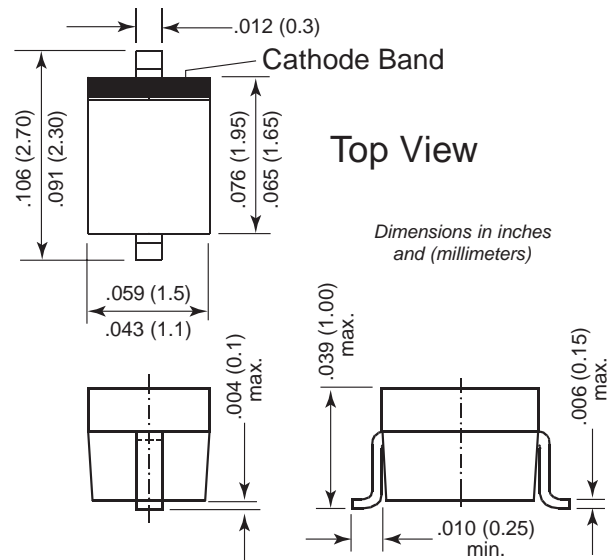
- RoHS Compliant Product
- High Current Capability
- Extremely Low Thermal Resistance
- For Surface Mount Application
- Higher Temp Soldering : 250°C for 10 Seconds at Terminals
- Low Forward Voltage

**MECHANICAL DATA**

- Case: Molded Plastic
- Epoxy: UL 94V-0 Rate Flame Retardant
- Lead: Axial Leads, Solderable per MIL-STD-202, Method208 Guaranteed.
- Weight: approx. 0.0045g
- Mounting Position: Any

Marking Vodes: BAT42WS=S7  
BAT43WS=S8

SOD-323(SC-76)



Dimensions in inches and (millimeters)

**Maximum Ratings** @  $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbo	BAT42WS / BAT43WS	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	30	V
RMS Reverse Voltage	$V_{R(RMS)}$	21	V
Forward Continuous Current (Note 1)	$I_{FM}$	200	mA
Repetitive Peak Forward Current (Note 1) @ $t < 1.0s$	$I_{FRM}$	500	mA
Non-Repetitive Peak Forward Surge Current @ $t < 10ms$	$I_{FSM}$	4.0	A
Power Dissipation	$P_d$	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{\theta JA}$	625	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_j, T_{STG}$	-55 to +125	$^\circ\text{C}$

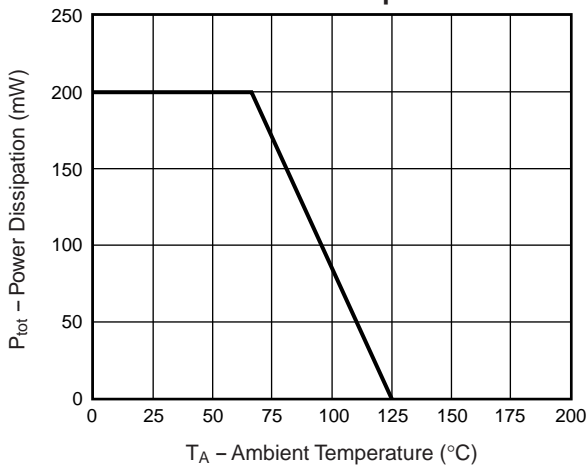
**Electrical Characteristics** @  $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	30	—	V	$I_R = 100\mu\text{A}$
Forward Voltage Drop (Note 2)	$V_{FM}$	—	1.0 0.40 0.65 0.33 0.45	V	$I_F = 200\text{mA}$ $I_F = 10\text{mA}$ $I_F = 50\text{mA}$ $I_F = 2.0\text{mA}$ $I_F = 15\text{mA}$
Peak Reverse Current (Note 2)	$I_{RM}$	—	500 100	nA $\mu\text{A}$	$V_R = 25\text{V}$ $V_R = 25\text{V}, T_j = 100^\circ\text{C}$
Total Capacitance	$C_T$	—	10	pF	$V_R = 1.0\text{V}, f = 1.0\text{MHz}$
Reverse Recovery Time	$t_{rr}$	—	5.0	ns	$I_F = I_R = 10\text{mA}$ , $I_{rr} = 0.1 \times I_R, R_L = 100\Omega$
Rectification Efficiency	$\eta_V$	80	—	%	$R_L = 15\Omega, C_L = 300\text{pF}$ , $f = 45\text{MHz}, V_{RF} = 2.0\text{V}$

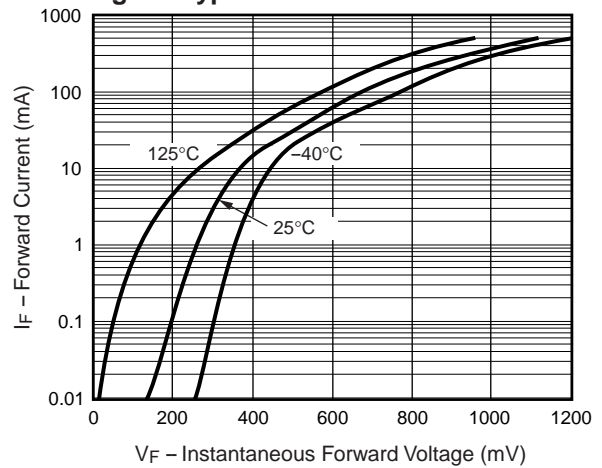
- Notes: 1. Part mounted on FR-4 board with recommended pad layout.  
2. Short duration pulse test used to minimize self-heating effect.

**Ratings and Characteristic Curves** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

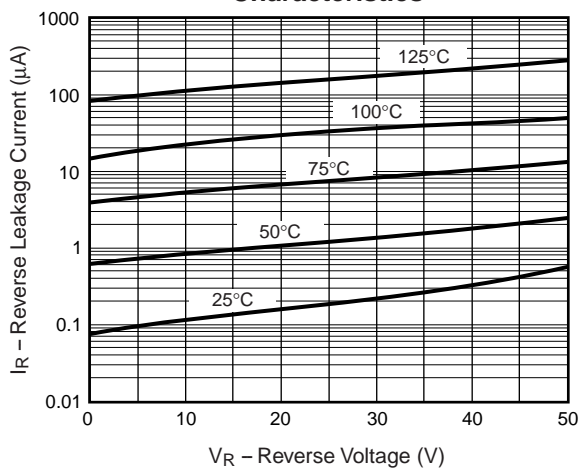
**Fig. 1 – Admissible Power Dissipation vs. Ambient Temperature**



**Fig. 2 – Typical Reverse Characteristics**



**Fig. 3 – Typical Reverse Characteristics**



**Fig. 4 – Typical Capacitance vs. Reverse Applied Voltage**

